REPORT DOCUMENTATION PAGE

Form Approved OMB No. 074-0188

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1. AGENCY USE ONLY (Leave blank) 2. REPORT DATE 3. REPORT TYPE AND DATES COVERED March 11, 2005 Final Technical (12/1/00-12/31/04)				
A THE CLIPTITE	March 11, 2005		JNDING NUMBERS	
4. TITLE AND SOUTHEL			nt #N00014-01-1-0038	
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6. AUTHOR(S)				
Hadis Morkos, Ph.D.				
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7. PERFORMING ORGANIZATION NAME(S) AND ADDRESS(ES) 8.			RFORMING ORGANIZATION PORT NUMBER	
Virginia Commonwealth University			Technical for #528657	
School of Engineering				
PO Box 843068 Richmond, VA 23284-3068				
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Office of Naval Research				
Program Officer, Colin E. Wood				
ONR Code 312				
Ballston Center Tower One 800 N. Quincy St., Arlington, VA	22217			
11. SUPPLEMENTARY NOTES				
12a. DISTRIBUTION / AVAILABILITY STATEMENT			12b. DISTRIBUTION CODE	
APPROVED FOR PUBLIC RELEASE				
13. ABSTRACT (Maximum 200 Work	<i>ds)</i> cen to enhance GaN quality during e	nitaxy and lead zirconate titana	ate (PZT) structures for sensors and	
A variety of approaches have been taken to enhance GaN quality during epitaxy and lead zirconate titanate (PZT) structures for sensors and data storage. GaN regrown on KOH etched templates with defective material removed has shown improved optical quality and				
demonstrated lateral growth by MBE. The same also carried out using MOCVD. GaN layers were also grown on closely lattice and				
stacking matched ZnO substrates. In this vein, we developed a high temperature thermal treatment for ZnO substrate. After 3 hours annealing in the air at 1050°C, all the surface damages were removed and straight, parallel terrace features were formed on the surface				
annealing in the air at 1050°C, all the surface damages were removed and straight, parallel terrace features were formed on the surface as judged by AFM images, which can facilitate smooth 2D growth and reduce column formation during the growth of GaN epilayers				
without the deleterious effects of a damaged substrate surface. Thin films of PZT were grown by sol-gel techniques on sapphire,				
Pt/Ti/SiO ₂ /Si and Ir/Ti/SiO ₂ /Si. For electrical characterization, the top electrodes for Au/PZT/Pt and Au/PZT/Ir capacitors were				
fabricated by photolithography and liftoff process, The polarization hysteresis and fatigue characteristics were measured by using a				
ferroelectric tester.				
14. SUBJECT TERMS			15. NUMBER OF PAGES	
Semiconductors, GaN			16. PRICE CODE	
17. SECURITY CLASSIFICATION	18. SECURITY CLASSIFICATION	19. SECURITY CLASSIFICATION	ON 20. LIMITATION OF ABSTRACT	
OF REPORT	OF THIS PAGE Unclassified	OF ABSTRACT Unclassified	SAR	
Unclassified	UNCLASSILLEG	OHCTGSSTTTER		

NSN 7540-01-280-5500

Standard Form 298 (Rev. 2-89) Prescribed by ANSI Std. Z39-18 298-102

Contract Information

Contract Number	N00014-01-1-0038	
Title of Research	Growth and investigation of a class of ferroelectric oxides for multifunctional devices	
Principal Investigator	gator Hadis Morkoc	
Organization	Virginia Commonwealth University	

Technical Section

Technical Objectives

Growth and characterization of a class of ferroelectric oxides for multifunctional device applications.

Technical Approach

In order to apply lead zirconate titanate (PZT) to functional devices such as sensors, surface acoustic wave (SAW) devices, and metal ferroelectric semiconductor field effect transistors (MFSFETs) by utilizing wide band gap semiconductors such as GaN, ZnO. As essential steps, PZT thin films with various compositions (Pb:Zr:Ti ratio) were grown by sol-gel techniques on various substrates, including sapphire, Pt/Ti/SiO₂/Si and Ir/Ti/SiO₂/Si substrates. For electrical characterization, the top electrodes for Au/PZT/Pt and Au/PZT/Ir capacitors were fabricated by photolithography and liftoff process, The Ir bottom electrodes were obtained through a collaboration with Samsung Advanced Institute of Technology. The photolithography and wet etching conditions (HF, HF:H₂O₂:HNO₃) were optimized to explore multifunctional device applications. The polarization hysteresis and fatigue characteristics were measured by using a ferroelectric tester.

Progress

1. Electrical characterization of sol-gel PZT

The Sol-gel method is cost effective and allows the compositions of PZT thin films to be changed with ease. We investigated sol-gel method and optimized the associated process parameters such as spin-coating, dry, hydrolysis, and annealing. PZT films were prepared using sol-gel method on Pt(111)/TiO₂/SiO₂/Si substrates or Ir(111)/Ti/SiO₂/Si substrates. The film deposition was performed by spin-coating of PZT precursor at 4000 rpm for 40 s and then dried at 200°C on a hot plate for 5 min. These steps were repeated until the desired film thickness (180 nm) was obtained. The films were then pyrolyzed at various temperatures ranging from 300°C to 400°C in order to remove the residual organic species, and then finally they were crystallized at higher temperatures in a preheated furnace in O₂ ambient.

To fabricate capacitor structures (Au/PZT/Pt and Au/PZT/Ir), 1000Å thick Au top electrode was deposited by thermal evaporation. For wet etching of PZT, 48% HF was normally used. For future multifunctional device applications such as sensors and metal ferroelectric semiconductor field effect transistor (MFSFET) fabrication processes need to be developed. In this vein HF: H₂O₂:HNO₃ = 1:30:1 etchant was found to exhibit the required selectivity. It was also found that a Au/Cr bilayer could be used to improve the adhesion of top electrode to PZT. Electrical measurements in terms of polarization hysteresis, and fatigue were conducted by using a ferroelectric tester (Radiant tech. Precision LC).

Figure 1 (a) and (b) show the polarization hysteresis of Au/PZT/Pt capacitor (denoted as SGPZT_I) with varying sweep voltage. The PZT film was annealed at 700° C for 10 min in air before Au evaporation. In Figure 1(a), the sweep voltage varies from ±1 to ± 7 V, and one can see the polarization saturation at around ± 5V. The maximum polarization (P_{max}) was 30.6 μ C/cm², the remnant polarization (P_r) was 20 μ C/cm², and coercive voltage (E_c) was 1.5 V (equivalently, 100 kV/cm). In Figure 1(b) represents a wider range of sweep voltages between ± 20 V. It turned out that the capacitor functions up to ± 18 V. It, however, failed at ± 20V (see leakage current at -20V).

Figure 2 shows the P_{max} , P_r and E_c at various sweep voltages. Throughout the range of 5 - 15V, a saturated $P_r \approx 26~\mu\text{C/cm}^2$ and an $E_c \approx 1.5\text{V}$ were obtained. Figure 3 shows the polarization hysteresis of Au/PZT/Pt capacitor RTA annealed at 750°C for 10s (denoted as SGPZT_II) (the anneal temperature is 50°C higher and anneal time was much shorter than that used for SGPZT_I). It can be seen that the polarization does not saturate even up to \pm 11 V, and leaky capacitor features appear at - 11 V. Figure 4 shows the polarization hysteresis of Au/PZT/Ir (denoted as SGPZT_III) which was RTA annealed at 550°C for 30 min, (150°C lower temperature and 20 min longer anneal time than SGPZT_I). One can see that the polarization does not saturate and the coercive voltage is larger than that for SGPZT_I, indicating that the anneal time of 10s was relatively short and the anneal temperature of 550°C was relatively low for ferroelectric capacitor fabrication.

Figure 5 shows the polarization change (dP/dV) of sample SGPZT_I, II, and III as a function of sweep voltage. It can be seen that the dP/dV of SGPZT_III shows a sharp/narrow peak at a certain voltage (coercive voltage) while the coercive voltage of SGPZT_III is larger than those for SGPZT_I and II. This may imply that statistically most ferroelectric domains in SGPZT_III are more readily switched at the coercive voltage compared to SGPZT_I and II.

Since we used Ir substrate only for SGPZT_III, it is temping to suggest that this feature may in some way be related to the substrate, i.e. Pt vs. Ir.

Figure 6 shows the polarization hysteresis curves of Au/PZT/Ir at different furnace anneal temperatures in air for 30min: 550 °C (sample SGPZT_IV), 600 °C (SGPZT_V), 650 °C, and 700°C (SGPZT_VI). A polarization gap at 0 V especially for the samples annealed at high temperatures (650, 700°C) was observed. It has been reported that the gap may be related to oxygen vacancies at Au/PZT and/or PZT/Ir interface [Appl. Phys. Lett. 69, 2540 (1996)]. In order to reduce the oxygen vacancies, the three samples under investigation were annealed again in oxygen/Ar mixture at 700°C for 10 min. Figure 7(a), (b) and (c) compare the normalized polarization hysteresis curves before and after annealing of SGPZT_IV, V, and VI, respectively. It is seen that after annealing the polarization gap at 0 V was reduced and also the coercive voltage decreased dramatically for all three samples, which might be related to defects (e.g. oxygen vacancies), annihilation at PZT film/Pt bottom electrode, and/or PZT/Au top electrode interface.

The polarization hysteresis curves of PZT on Pt/Ti/SiO₂/Si and PZT on Ir/Ti/SiO₂/Si substrates have been compared. Figure 8(a) shows the polarization hysteresis of Au/PZT/Pt annealed at 600°C for 10 min (denoted SGPZT VII). The sweep voltage varied from ± 3 V to ± 8V and beyond \pm 5V the polarization saturated and at 5V, $P_{max} = 33.3 \ \mu \text{C/cm}^2$, $P_r = 17.1 \ \mu \text{C/cm}^2$, and $E_c = 1.26 \text{ V}$ (84 kV/cm). Figure 8 (b) shows the fatigue (degradation) properties of SGPZT VII with the standard positive up negative down (PUND) test. [http://www.ferrodevices.com]. The PUND stress frequency is 10⁶ Hz. It is seen that after 10¹⁰ cycles the polarization decreased to about 60% of the initial value, while as shown in Figure 9(a) the Au/PZT/Ir annealed at 600°C for 10 min (denoted SGPZT_VIII) has $P_{max} = 41.1 \mu C/cm^2$, $P_r = 41.1 \mu C/cm^2$ 22.7 μ C/cm², and E_c = 1.5 V (100.7 kV/cm) at 5 V. Figure 9 (b) represents the PUND test result for SGPZT VIII. Up to 10⁸ cycles no noticeable degradation is observed. One of the well-known degradation mechanism of PZT grown on Pt is oxygen vacancy accumulation at the PZT/Pt (top and/or bottom electrode)interface. In this vein, the PZT/Ir interface may offer better resistance to oxygen accumulation and thus better fatigue properties could be obtained. Further understanding about the degradation mechanism and investigations of fatigue free electrode such as RuO₂, LSCO (La_{0.5} Sr_{0.5}CoO₃), SrRuO₃, hybrid Ir/irO₂ are needed for near future multifunctional device applications.

2. Works in progress:

(1) Using STO buffer layers, the PZT/STO/ Pt/TiO₂/SiO_x/Si are being grown. We have grown several samples and are in the process of optimizing the growth conditions in order to get excellent electrical properties such as low coercive voltage, high remnant polarization, fatigue free capacitors, etc. (2) We have started to work on realizing lateral polarization on PZT thin films, which may be highly sensitive to irradiation by light or humidity compared to vertical polarization in PZT thin films. This aspect can be utilized for sensors. We plan to use sol-gel solutions of Pb(Zn_{0.2}Ti_{0.8})O₃ and La-doped PbLaZnTiO₃ (PLZT) to optimize horizontal polarization. (3) One of the main tasks now is to grow high quality thin films with enhanced repeatability and uniformity. Next work is to make multi-function devices e.g. multifunctional sensors utilizing surface acoustic wave (SAW) principle or metal ferroelectric semiconsuctor field effect transistor (MFSFET) using wide bandgap semiconductors such as GaN, ZnO and

SiC. In terms of the deposition, all the components and parts needed for growing PZT films by MBE are in place. As soon as the work being done in the MBE system slated for this work is transferred to a new II-VI MBE, the system will be available and used for PZT investigations. The aim is to ascertain whether films with better polarization features and fatigue characteristics could be obtained.

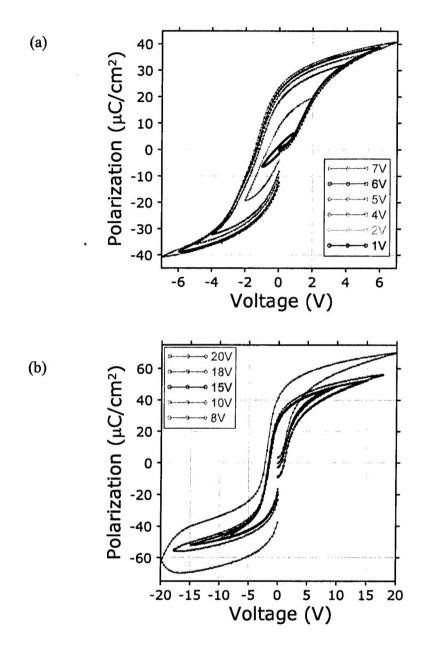


Figure 1(a). Polarization hysteresis loops of Au/PZT/Pt (700°C, 10 min RTA in air) at various sweep voltage ± 1 , ± 2 , ± 4 , ± 5 , ± 6 , ± 7 V. (b) Sweep voltage ± 8 , ± 10 , ± 15 , ± 18 , ± 20 V.

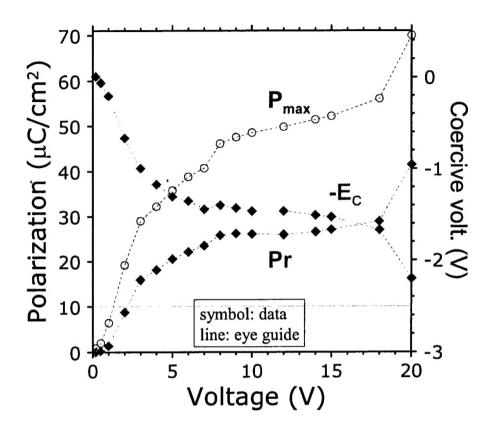


Figure 2. Maximum polarization (P_{max}), remnant polarization (P_r), and coercive voltage (E_c) at various sweep voltage.

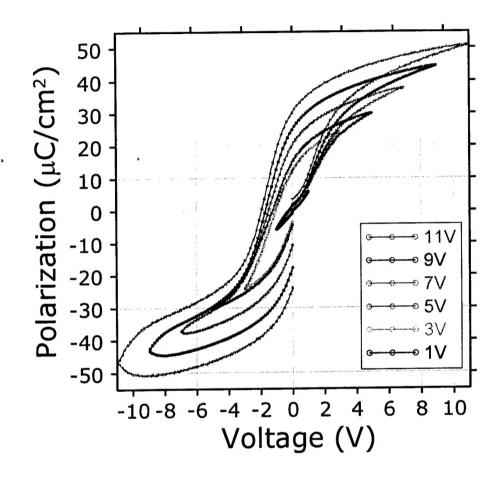


Figure 3. Polarization hysteresis loops of Au/PZT/Pt (750°C, 10 s RTA in air) at various sweep voltage $\pm 1, \pm 3, \pm 5, \pm 7, \pm 9, \pm 11$ V.

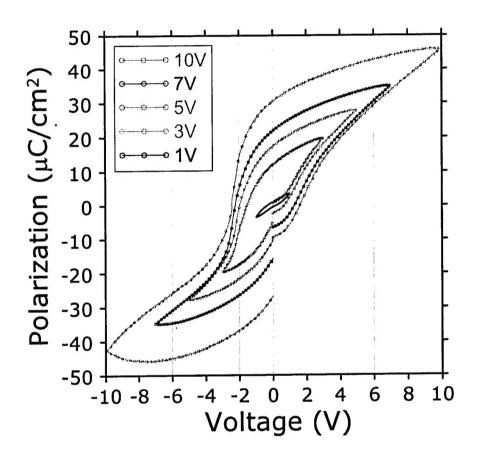


Figure 4. Polarization hysteresis loops of Au/PZT/Ir (550°C, 30 min furnace anneal in air) at various sweep voltage ± 1 , ± 3 , ± 5 , ± 7 , ± 10 V.

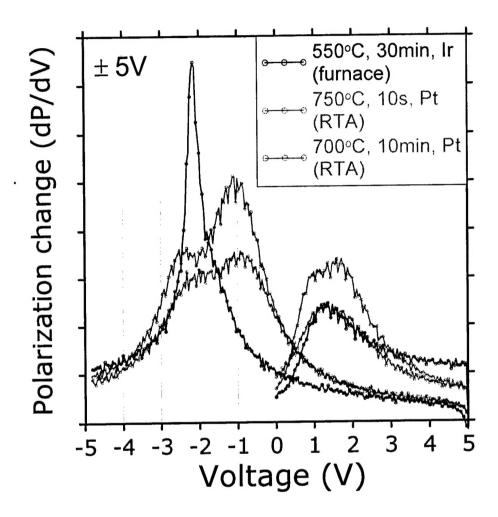


Figure 5. Polarization change (dP/dV) vs. voltage of Au/PZT/Ir (550°C, 30 min furnace anneal in air), Au/PZT/Pt (700°C, 10 min RTA in air), and Au/PZT/Pt (750°C, 10 s RTA in air).

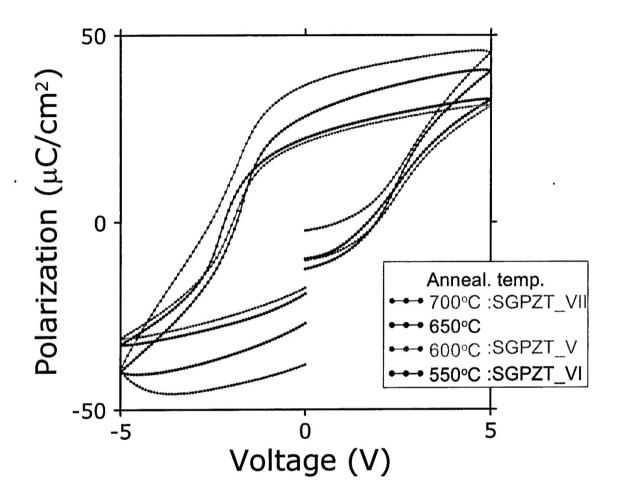


Figure 6. Polarization vs. voltage hysteresis loops of Au/PZT/Ir at various annealing temperature (550, 600, 650, and 700°C) in air for 30 min

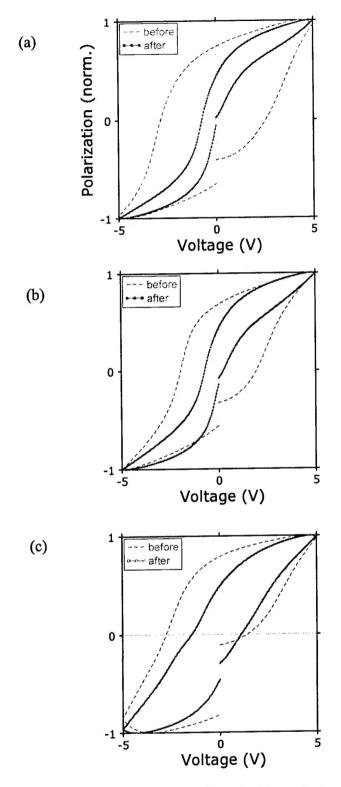
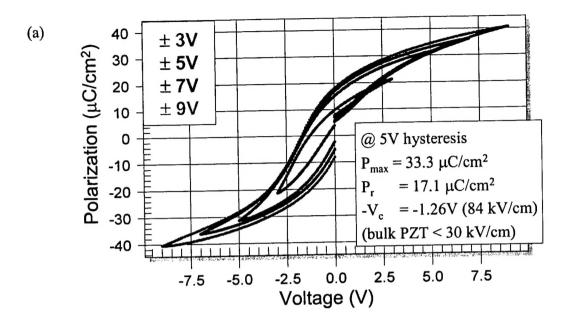


Figure 7. Normalized polarization vs. voltage before and after annealing in O₂/Ar ambient at 700°C for 10 min: (a) SGPZT_IV, (b) SGPZT_V, and (c) SGPZT_VI.



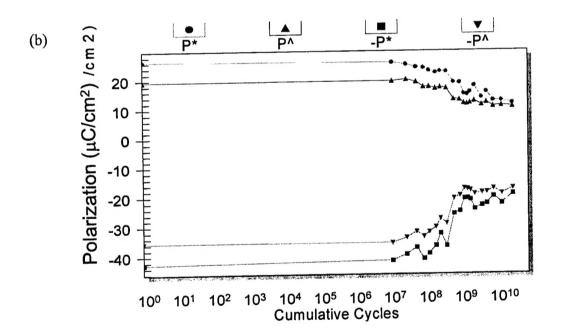
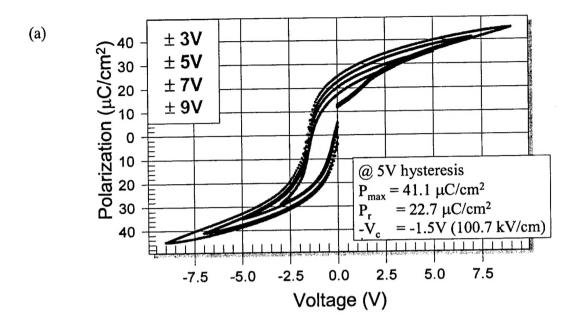


Figure 8. (a) Polarization hysteresis loops of Au/PZT/Pt (600°C, 10 min RTA in air) at various sweep voltage ± 3 , ± 5 , ± 7 , ± 9 V. (b) Polarization fatigue curves (PUND test), frequency = 10^6 Hz.



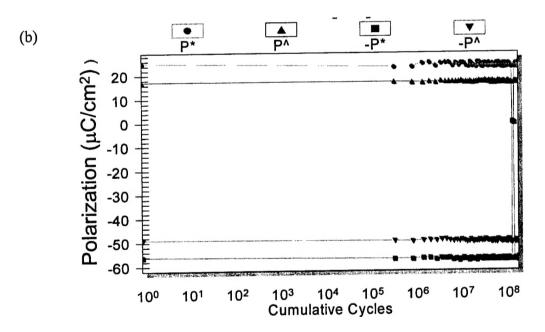


Figure 9. (a) Polarization hysteresis loops of Au/PZT/Ir (600°C, 10 min RTA in air) at various sweep voltage ± 3 , ± 5 , ± 7 , ± 9 V. (b) Polarization fatigue curves (PUND test), frequency = 10^6 Hz